

ECTC 2006

The 56th Electronic Components
and Technology Conference

May 30 - June 2, 2006

Sheraton San Diego Hotel & Marina
San Diego, California

The only event
that encompasses
the diverse world
of integrated
systems packaging

HIGHLIGHTS

- 38 technical sessions, including 2 poster sessions
- 16 CEU-approved professional development courses
- Technology Corner Exhibits, featuring more than 70 industry-leading vendors
- Emerging Technology Sessions, including Biomedical, Nano-Scale and Organic Device Packaging
- Panel Discussion – 3D Interconnect
- Plenary Session – Packaging Solutions for Future Technologies
- Third iNEMI Workshop on Tin Whiskers
- CPMT Academic Conference

More than 300 technical papers covering:

- Advanced Packaging
- Modeling & Simulation
- Optoelectronics
- Interconnections
- Materials & Processing
- Quality & Reliability
- Manufacturing Technology
- Components & RF
- Packaging Education

Don't miss out on the industry's premier event. For more information, visit:

www.ectc.net

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